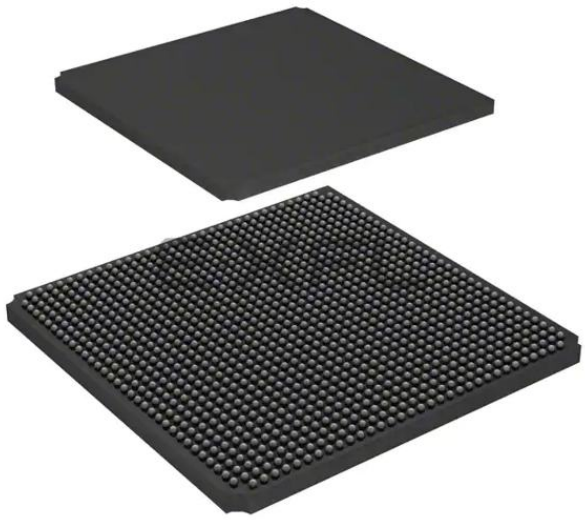
Lattice Semiconductor Corporation - LFE2M70SE-5FN1152C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

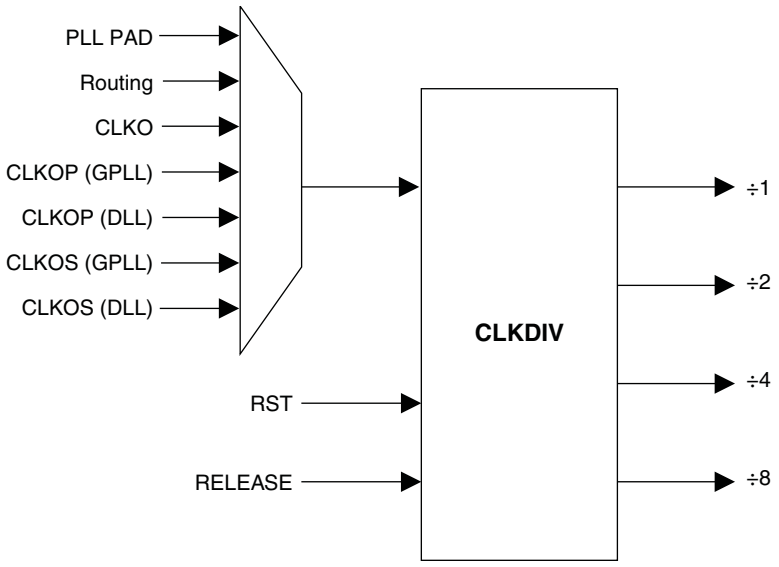
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Not For New Designs
Number of LABs/CLBs	8375
Number of Logic Elements/Cells	67000
Total RAM Bits	4642816
Number of I/O	436
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m70se-5fn1152c

Figure 2-9. Clock Divider Connections



Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

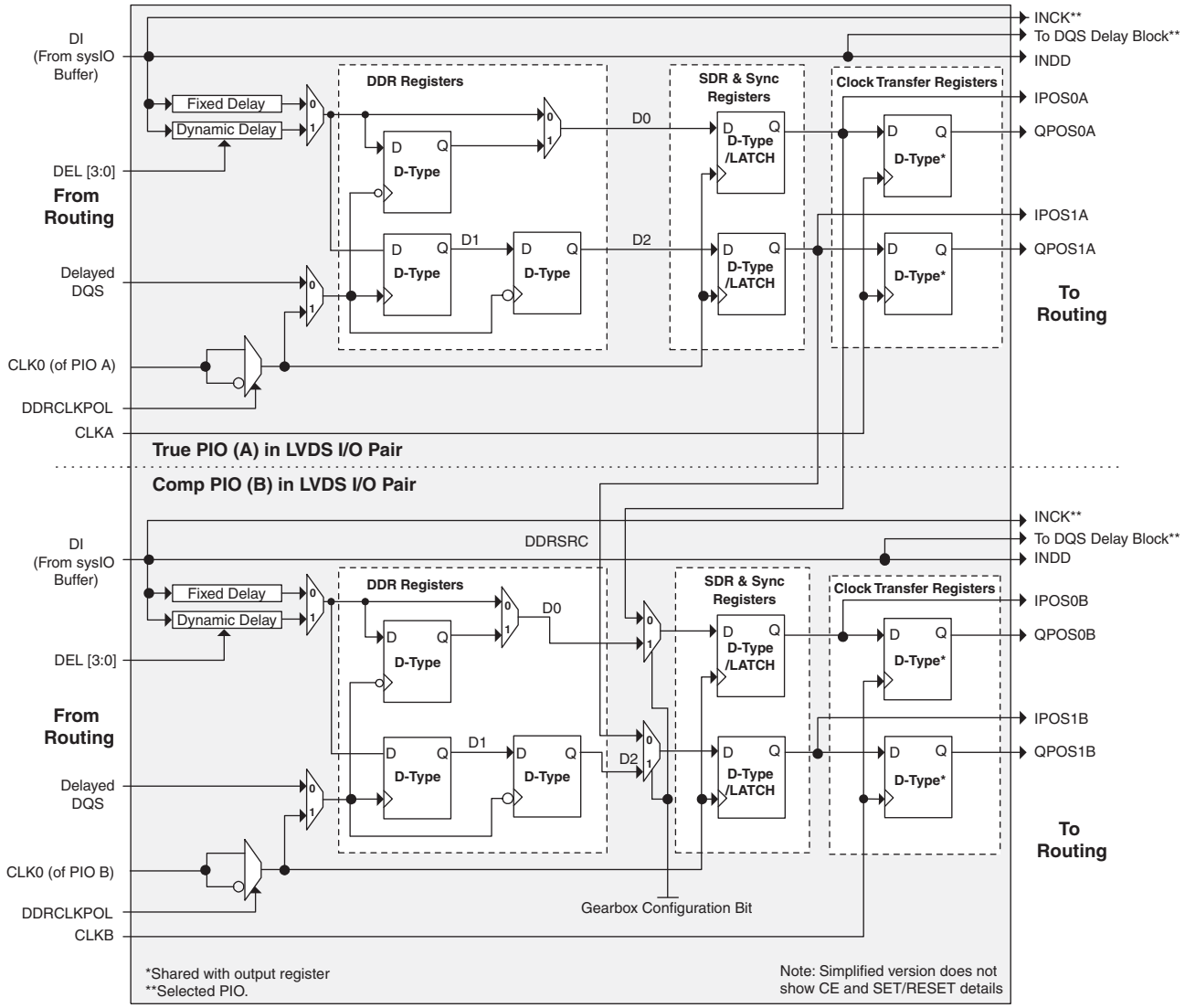
Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLKDIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

Figure 2-29. Input Register Block for Left, Right and Bottom Edges



IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP2/M devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant Test Access Port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP2/M devices contain two ports that can be used for device configuration. The Test Access Port (TAP), which supports bit-wide configuration, and the sysCONFIG port, support both byte-wide and serial configuration, including the standard SPI Flash interface. The TAP supports both the IEEE Standard 1149.1 Boundary Scan specification and the IEEE Standard 1532 In- System Configuration specification. The sysCONFIG port is a 20-pin interface with six I/Os used as dedicated pins with the remainder used as dual-use pins. See TN1108, LatticeECP2/M sysCONFIG Usage Guide for more information about using the dual-use pins as general purpose I/Os.

On power-up, the FPGA SRAM is ready to be configured using the selected sysCONFIG port. Once a configuration port is selected, it will remain active throughout that configuration cycle. The IEEE 1149.1 port can be activated any time after power-up by sending the appropriate command through the TAP port.

Enhanced Configuration Option

LatticeECP2/M devices have enhanced configuration features such as: decryption support, TransFR™ I/O and dual boot image support.

1. **Decryption Support**
   LatticeECP2/M devices provide on-chip, One Time Programmable (OTP) non-volatile key storage to support decryption of a 128-bit AES encrypted bitstream, securing designs and deterring design piracy.

2. **TransFR (Transparent Field Reconfiguration)**
   TransFR I/O (TFR) is a unique Lattice technology that allows users to update their logic in the field without interrupting system operation using a single ispVM® command. TransFR I/O allows I/O states to be frozen during device configuration. This allows the device to be field updated with a minimum of system disruption and downtime. See TN1087, Minimizing System Interruption During Configuration Using TransFR Technology, for details.

3. **Dual Boot Image Support**
   Dual boot images are supported for applications requiring reliable remote updates of configuration data for the system FPGA. After the system is running with a basic configuration, a new boot image can be downloaded remotely and stored in a separate location in the configuration storage device. Any time after the update the LatticeECP2/M can be re-booted from this new configuration file. If there is a problem, such as corrupt data during download or incorrect version number with this new boot image, the LatticeECP2/M device can revert back to the original backup configuration and try again. This all can be done without power cycling the system.

For more information about device configuration, please see the list of additional technical documentation at the end of this data sheet.

Soft Error Detect (SED) Support

LatticeECP2/M devices have dedicated logic to perform CRC checks. During configuration, the configuration data bitstream can be checked with the CRC logic block. In addition, the LatticeECP2 device can also be programmed

sysI/O Recommended Operating Conditions

Standard	V_{CCIO}			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 3.3[2]	3.135	3.3	3.465	—	—	—
LVCMOS 2.5[2]	2.375	2.5	2.625	—	—	—
LVCMOS 1.8	1.71	1.8	1.89	—	—	—
LVCMOS 1.5	1.425	1.5	1.575	—	—	—
LVCMOS 1.2[2]	1.14	1.2	1.26	—	—	—
LVTTL[2]	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18[2] Class I, II	1.71	1.8	1.89	0.833	0.9	0.969
SSTL2[2] Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3[2] Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL[2] 15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL[2] 18 Class I, II	1.71	1.8	1.89	0.816	0.9	1.08
LVDS[2]	2.375	2.5	2.625	—	—	—
MLVDS25[1]	2.375	2.5	2.625	—	—	—
LVPECL33[1, 2]	3.135	3.3	3.465	—	—	—
BLVDS25[1, 2]	2.375	2.5	2.625	—	—	—
RSDS[1, 2]	2.375	2.5	2.625	—	—	—
SSTL18D_I[2], II[2]	1.71	1.8	1.89	—	—	—
SSTL25D_ I[2], II[2]	2.375	2.5	2.625	—	—	—
SSTL33D_ I[2], II[2]	3.135	3.3	3.465	—	—	—
HSTL15D_ I[2]	1.425	1.5	1.575	—	—	—
HSTL18D_ I[2], II[2]	1.71	1.8	1.89	—	—	—

1. Inputs on chip. Outputs are implemented with the addition of external resistors.
2. Input on this standard does not depend on the value of V_{CCIO}.

BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

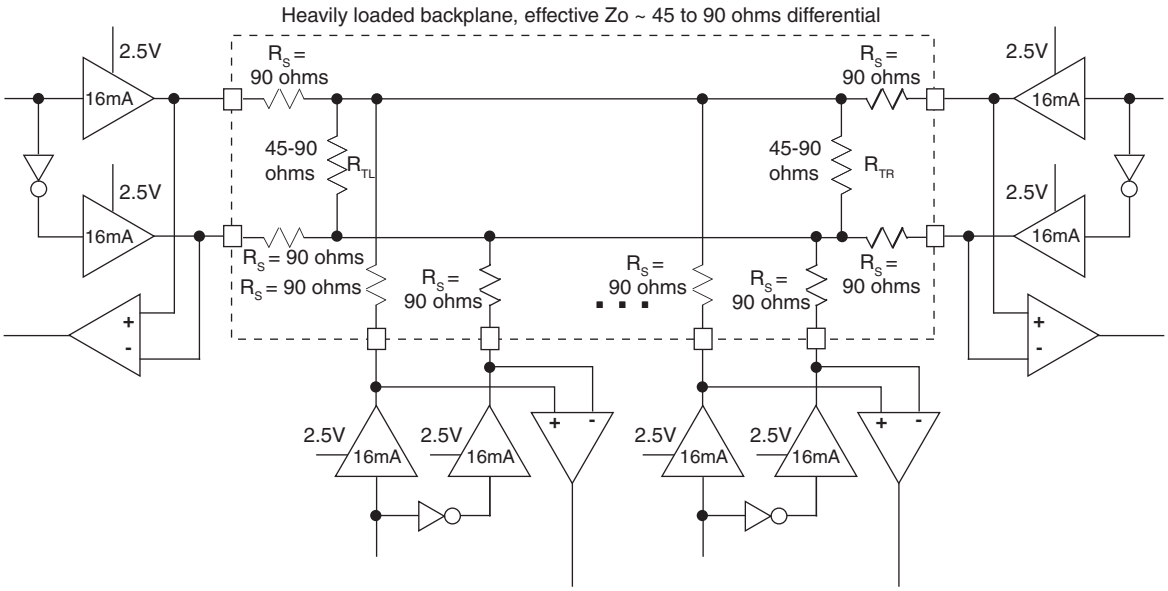


Table 3-3. BLVDS DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45Ω	Zo = 90Ω	
V_{CCIO}	Output Driver Supply (+/- 5%)	2.50	2.50	V
Z_{OUT}	Driver Impedance	10.00	10.00	Ω
R_S	Driver Series Resistor (+/- 1%)	90.00	90.00	Ω
R_{TL}	Driver Parallel Resistor (+/- 1%)	45.00	90.00	Ω
R_{TR}	Receiver Termination (+/- 1%)	45.00	90.00	Ω
V_{OH}	Output High Voltage	1.38	1.48	V
V_{OL}	Output Low Voltage	1.12	1.02	V
V_{OD}	Output Differential Voltage	0.25	0.46	V
V_{CM}	Output Common Mode Voltage	1.25	1.25	V
I_{DC}	DC Output Current	11.24	10.20	mA

1. For input buffer, see LVDS table.

LatticeECP2/M Internal Switching Characteristics[1] (Continued)

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{HWREN_EBR}	Hold Write/Read Enable to PFU Memory	0.139	—	0.156	—	0.173	—	ns
t_{SUCE_EBR}	Clock Enable Setup Time to EBR Output Register	0.123	—	0.134	—	0.145	—	ns
t_{HCE_EBR}	Clock Enable Hold Time to EBR Output Register	-0.081	—	-0.090	—	-0.100	—	ns
t_{RSTO_EBR}	Reset To Output Delay Time from EBR Output Register	—	1.03	—	1.15	—	1.26	ns
t_{SUBE_EBR}	Byte Enable Set-Up Time to EBR Output Register	-0.115	—	-0.130	—	-0.145	—	ns
t_{HBE_EBR}	Byte Enable Hold Time to EBR Output Register	0.138	—	0.155	—	0.172	—	ns
GPLL Parameters								
t_{RSTREC_GPLL}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
SPLL Parameters								
t_{RSTREC_SPLL}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
DSP Block Timing[2,3]								
t_{SUI_DSP}	Input Register Setup Time	0.12	—	0.13	—	0.14	—	ns
t_{HI_DSP}	Input Register Hold Time	0.02	—	-0.01	—	-0.03	—	ns
t_{SUP_DSP}	Pipeline Register Setup Time	2.18	—	2.42	—	2.66	—	ns
t_{tHP_DSP}	Pipeline Register Hold Time	-0.68	—	-0.77	—	-0.86	—	ns
t_{SUO_DSP}	Output Register Setup Time	4.26	—	4.71	—	5.16	—	ns
t_{HO_DSP}	Output Register Hold Time	-1.25	—	-1.40	—	-1.54	—	ns
t_{COI_DSP}	Input Register Clock to Output Time	—	3.92	—	4.30	—	4.68	ns
t_{COP_DSP}	Pipeline Register Clock to Output Time	—	1.87	—	1.98	—	2.08	ns
t_{COO_DSP}	Output Register Clock to Output Time	—	0.50	—	0.52	—	0.55	ns
$t_{SUADDSUB}$	AddSub Input Register Setup Time	-0.24	—	-0.26	—	-0.28	—	ns
$t_{HADDSUB}$	AddSub Input Register Hold Time	0.27	—	0.29	—	0.32	—	ns

1. Internal parameters are characterized but not tested on every device.
2. These parameters apply to LatticeECP devices only.
3. DSP Block is configured in Multiply Add/Sub 18x18 Mode.

Table 3-13. Periodic Receiver Jitter Tolerance Specification[1]

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Periodic	3.125 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	2.5 Gbps	600 mV differential eye	—	—	0.22	UI, p-p
	1.25 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	250 Mbps[2]	600 mV differential eye	—	—	0.08	UI, p-p

1. Values are measured with PRBS 2^7-1, all channels operating.
2. Jitter specification is limited by measurement equipment capability.

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70 (Cont.)

Pin Type		LFE2-50		LFE2-70	
		484 fpBGA	672 fpBGA	672 fpBGA	900 fpBGA
Available DDR-Interfaces per I/O Bank[1]	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	2	3	3	4
	Bank3	0	3	3	3
	Bank4	3	4	4	4
	Bank5	3	4	4	5
	Bank6	1	4	4	4
	Bank7	2	3	3	4
	Bank8	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	0	0	0	0
	Bank3	0	0	0	0
	Bank4	46	62	62	72
	Bank5	46	68	68	80
	Bank6	0	0	0	0
	Bank7	0	0	0	0
	Bank8	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
U9	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
W9	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-			GNDIO5	-		
V9	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
Y8	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AA8	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
W10	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
V10	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
AB8	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AA9	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
AB9	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AB10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
Y10	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
AA10	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
U10	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
U11	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
VCCIO	VCCIO5	5			VCCIO	5		
AB11	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AA11	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y11	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
W11	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AB12	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AA12	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AB13	PB35A	5	PCLKT5_0/BDQ33	T	PB44A	5	PCLKT5_0/BDQ42	T
AB14	PB35B	5	PCLKC5_0/BDQ33	C	PB44B	5	PCLKC5_0/BDQ42	C
VCCIO	VCCIO5	5			VCCIO	5		
GNDIO	GNDIO5	-			GNDIO5	-		
U12	PB40A	4	PCLKT4_0/BDQ42	T	PB49A	4	PCLKT4_0/BDQ51	T
VCCIO	VCCIO4	4			VCCIO	4		
V12	PB40B	4	PCLKC4_0/BDQ42	C	PB49B	4	PCLKC4_0/BDQ51	C
Y12	PB41A	4	BDQ42	T	PB50A	4	BDQ51	T
W12	PB41B	4	BDQ42	C	PB50B	4	BDQ51	C
AA13	PB42A	4	BDQS42	T	PB51A	4	BDQS51	T
GNDIO	GNDIO4	-			GNDIO4	-		
Y13	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C
U13	PB43A	4	BDQ42	T	PB52A	4	BDQ51	T
U14	PB43B	4	BDQ42	C	PB52B	4	BDQ51	C
AB15	PB44A	4	BDQ42	T	PB53A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO	4		
AA14	PB44B	4	BDQ42	C	PB53B	4	BDQ51	C
AB16	PB45A	4	BDQ42	T	PB54A	4	BDQ51	T
AB17	PB45B	4	BDQ42	C	PB54B	4	BDQ51	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K8	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L12	GND	-			GND	-		
L13	GND	-			GND	-		
L15	GND	-			GND	-		
L8	GND	-			GND	-		
M10	GND	-			GND	-		
M11	GND	-			GND	-		
M12	GND	-			GND	-		
M13	GND	-			GND	-		
M15	GND	-			GND	-		
M8	GND	-			GND	-		
N10	GND	-			GND	-		
N11	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N15	GND	-			GND	-		
N8	GND	-			GND	-		
P14	GND	-			GND	-		
P20	GND	-			GND	-		
P3	GND	-			GND	-		
P9	GND	-			GND	-		
R10	GND	-			GND	-		
R11	GND	-			GND	-		
R12	GND	-			GND	-		
R13	GND	-			GND	-		
U17	GND	-			GND	-		
U6	GND	-			GND	-		
W2	GND	-			GND	-		
W21	GND	-			GND	-		
Y14	GND	-			GND	-		
Y9	GND	-			GND	-		
A1	GND	-			GND	-		
N18	VCCPLL	-			VCCPLL	-		
K6	NC	-			VCCPLL	-		
N6	VCCPLL	-			VCCPLL	-		
J16	NC	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA14	PB29B	5	BDQ33	C	PB29B	5	BDQ33	C
AE10	PB30A	5	BDQ33	T	PB30A	5	BDQ33	T
AF10	PB30B	5	BDQ33	C	PB30B	5	BDQ33	C
W14	PB31A	5	BDQ33	T	PB31A	5	BDQ33	T
AB13	PB31B	5	BDQ33	C	PB31B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
Y14	PB32A	5	BDQ33	T	PB32A	5	BDQ33	T
AB14	PB32B	5	BDQ33	C	PB32B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AE11	PB33A	5	BDQS33	T	PB33A	5	BDQS33	T
AF11	PB33B	5	BDQ33	C	PB33B	5	BDQ33	C
AD14	PB34A	5	BDQ33	T	PB34A	5	BDQ33	T
AA15	PB34B	5	BDQ33	C	PB34B	5	BDQ33	C
AE12	PB35A	5	PCLKT5_0/BDQ33	T	PB35A	5	PCLKT5_0/BDQ33	T
AF12	PB35B	5	PCLKC5_0/BDQ33	C	PB35B	5	PCLKC5_0/BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
GND	GNDIO5	-			GNDIO5	-		
AD15	PB40A	4	PCLKT4_0/BDQ42	T	PB40A	4	PCLKT4_0/BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
AC15	PB40B	4	PCLKC4_0/BDQ42	C	PB40B	4	PCLKC4_0/BDQ42	C
AE13	PB41A	4	BDQ42	T	PB41A	4	BDQ42	T
AF13	PB41B	4	BDQ42	C	PB41B	4	BDQ42	C
AB17	PB42A	4	BDQS42	T	PB42A	4	BDQS42	T
GND	GNDIO4	-			GNDIO4	-		
Y15	PB42B	4	BDQ42	C	PB42B	4	BDQ42	C
AE14	PB43A	4	BDQ42	T	PB43A	4	BDQ42	T
AF14	PB43B	4	BDQ42	C	PB43B	4	BDQ42	C
AA16	PB44A	4	BDQ42	T	PB44A	4	BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
W15	PB44B	4	BDQ42	C	PB44B	4	BDQ42	C
AC17	PB45A	4	BDQ42	T	PB45A	4	BDQ42	T
AB16	PB45B	4	BDQ42	C	PB45B	4	BDQ42	C
AE15	PB46A	4	BDQ42	T	PB46A	4	BDQ42	T
GND	GNDIO4	-			GNDIO4	-		
AF15	PB46B	4	BDQ42	C	PB46B	4	BDQ42	C
AE16	PB47A	4	BDQ51	T	PB47A	4	BDQ51	T
AF16	PB47B	4	BDQ51	C	PB47B	4	BDQ51	C
Y16	PB48A	4	BDQ51	T	PB48A	4	BDQ51	T
AB18	PB48B	4	BDQ51	C	PB48B	4	BDQ51	C
AD17	PB49A	4	BDQ51	T	PB49A	4	BDQ51	T
AD18	PB49B	4	BDQ51	C	PB49B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
AC18	PB50A	4	BDQ51	T	PB50A	4	BDQ51	T
AD19	PB50B	4	BDQ51	C	PB50B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
AC19	PB51A	4	BDQS51	T	PB51A	4	BDQS51	T

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AB6	PB17A	5	PCLKT5_0/BDQ15	T	PB35A	5	PCLKT5_0/BDQ33	T
AB7	PB17B	5	PCLKC5_0/BDQ15	C	PB35B	5	PCLKC5_0/BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AA8	PB22A	4	PCLKT4_0/BDQ24	T	PB40A	4	PCLKT4_0/BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
AB8	PB22B	4	PCLKC4_0/BDQ24	C	PB40B	4	PCLKC4_0/BDQ42	C
AA9	PB23A	4	VREF2_4/BDQ24	T	PB41A	4	VREF2_4/BDQ42	T
Y9	PB23B	4	VREF1_4/BDQ24	C	PB41B	4	VREF1_4/BDQ42	C
AB9	PB24A	4	BDQS24****	T	PB42A	4	BDQS42****	T
GNDIO	GNDIO4	-			GNDIO4	-		
AB10	PB24B	4	BDQ24	C	PB42B	4	BDQ42	C
AA10	PB25A	4	BDQ24	T	PB43A	4	BDQ42	T
Y11	PB25B	4	BDQ24	C	PB43B	4	BDQ42	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
V10	PB29A	4	BDQ33	T	PB47A	4	BDQ51	T
U11	PB29B	4	BDQ33	C	PB47B	4	BDQ51	C
V11	PB30A	4	BDQ33	T	PB48A	4	BDQ51	T
W11	PB30B	4	BDQ33	C	PB48B	4	BDQ51	C
AA11	PB31A	4	BDQ33	T	PB49A	4	BDQ51	T
AB11	PB31B	4	BDQ33	C	PB49B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
T11	PB32A	4	BDQ33	T	PB50A	4	BDQ51	T
U12	PB32B	4	BDQ33	C	PB50B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO4	-		
AA12	PB33A	4	BDQS33	T	PB51A	4	BDQS51	T
Y12	PB33B	4	BDQ33	C	PB51B	4	BDQ51	C
V12	PB34A	4	BDQ33	T	PB52A	4	BDQ51	T
W12	PB34B	4	BDQ33	C	PB52B	4	BDQ51	C
AB12	PB35A	4	BDQ33	T	PB53A	4	BDQ51	T
AA13	PB35B	4	BDQ33	C	PB53B	4	BDQ51	C
VCCIO	VCCIO4	4			VCCIO4	4		
T12	PB36A	4	BDQ33	T	PB54A	4	BDQ51	T
U13	PB36B	4	BDQ33	C	PB54B	4	BDQ51	C
V13	PB37A	4	BDQ33	T	PB55A	4	BDQ51	T
T13	PB37B	4	BDQ33	C	PB55B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO4	-		
AB13	PB38A	4	BDQ42	T	PB56A	4	BDQ60	T
AB14	PB38B	4	BDQ42	C	PB56B	4	BDQ60	C
U14	PB39A	4	BDQ42	T	PB57A	4	BDQ60	T
T14	PB39B	4	BDQ42	C	PB57B	4	BDQ60	C
AA14	PB40A	4	BDQ42	T	PB58A	4	BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
Y14	PB40B	4	BDQ42	C	PB58B	4	BDQ60	C
W14	PB41A	4	BDQ42	T	PB59A	4	BDQ60	T
V14	PB41B	4	BDQ42	C	PB59B	4	BDQ60	C
AB15	PB42A	4	BDQS42	T	PB60A	4	BDQS60	T

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F11	VCCIO0	0			VCCIO0	0		
J13	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	1		
D18	VCCIO1	1			VCCIO1	1		
F16	VCCIO1	1			VCCIO1	1		
J14	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
G25	VCCIO2	2			VCCIO2	2		
L21	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M25	VCCIO2	2			VCCIO2	2		
N18	VCCIO2	2			VCCIO2	2		
P18	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R25	VCCIO3	3			VCCIO3	3		
T21	VCCIO3	3			VCCIO3	3		
Y25	VCCIO3	3			VCCIO3	3		
AA16	VCCIO4	4			VCCIO4	4		
AC18	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V14	VCCIO4	4			VCCIO4	4		
AA11	VCCIO5	5			VCCIO5	5		
V13	VCCIO5	5			VCCIO5	5		
AE12	VCCIO5	5			VCCIO5	5		
AE7	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
P9	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R2	VCCIO6	6			VCCIO6	6		
T6	VCCIO6	6			VCCIO6	6		
Y2	VCCIO6	6			VCCIO6	6		
G2	VCCIO7	7			VCCIO7	7		
L6	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M2	VCCIO7	7			VCCIO7	7		
N9	VCCIO7	7			VCCIO7	7		
AC24	VCCIO8	8			VCCIO8	8		
U17	VCCIO8	8			VCCIO8	8		
J11	VCCAUX	-			VCCAUX	-		
J12	VCCAUX	-			VCCAUX	-		
J15	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
M18	VCCAUX	-			VCCAUX	-		
M9	VCCAUX	-			VCCAUX	-		
R18	VCCAUX	-			VCCAUX	-		
R9	VCCAUX	-			VCCAUX	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-			GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
GNDIO	GNDIO7	-			-	-		
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7		T	PL14A	7	LDQ15	T
D1	PL14B	7		C	PL14B	7	LDQ15	C
-	-	-			GNDIO7	-		
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*
K7	NC	-			PL16A	7	LDQ15	T
K8	NC	-			PL16B	7	LDQ15	C
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*
F1	NC	-			PL18A	7	LDQ15	T
-	-	-			GNDIO7	-		
G3	NC	-			PL18B	7	LDQ15	C
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*
J5	PL16A	7		T	PL22A	7		T
J4	PL16B	7		C	PL22B	7		C
GNDIO	GNDIO7	-			GNDIO7	-		
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*
L9	NC	-			PL25A	7	LDQ28	T
L7	NC	-			PL25B	7	LDQ28	C
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*
L8	NC	-			PL27A	7	LDQ28	T
L6	NC	-			PL27B	7	LDQ28	C
-	-	-			GNDIO7	-		
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*
N8	PL19A	7		T	PL29A	7	LDQ28	T
M9	PL19B	7		C	PL29B	7	LDQ28	C
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*
VCCIO	VCCIO7	7			-	-		
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*
H1	PL21A	7		T	PL31A	7	LDQ28	T
GNDIO	GNDIO7	-			GNDIO7	-		
J1	PL21B	7		C	PL31B	7	LDQ28	C
-	-	-			-	-		
-	-	-			-	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AJ17	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
AF26	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
AE25	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
GNDIO	GNDIO4	-			GNDIO4	-		
AD24	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AE24	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AD18	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T
AC18	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C
AE18	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T
AG19	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AC19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T
AD20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C
AB18	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T
AC20	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C
AE20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T
AE21	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
AC23	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T
AD23	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C
GNDIO	GNDIO4	-			GNDIO4	-		
AH18	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13		
AK19	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T
AJ18	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13		
AJ19	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C
AH21	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13		
AK22	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T
AK21	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13		
AJ22	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C
AH22	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13		
AJ23	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C
AH23	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13		
AK23	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T
AH19	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13		
AJ20	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AH20	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AK20	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AH24	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AG24	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AF24	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AJ24	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AK28	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AH28	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AJ28	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AH29	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13		
AK25	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E13	PT28A	0		T	PT37A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
GNDIO	GNDIO0	-			GNDIO0	-		
J12	PT5B	0		C	PT31B	0		C
GNDIO	GNDIO0	-			-	-		
VCCIO	VCCIO0	0			VCCIO0	0		
H10	PT5A	0		T	PT31A	0		T
E12	PT4B	0		C	PT30B	0		C
D11	PT4A	0		T	PT30A	0		T
H11	PT3B	0		C	PT29B	0		C
F11	PT3A	0		T	PT29A	0		T
C13	VCC	-			ULC_SQ_VCCRX0	11		
A12	PT19A	0		T	ULC_SQ_HDINP0	11		T
B13	NC	-			ULC_SQ_VCCIB0	11		
B12	PT19B	0		C	ULC_SQ_HDINN0	11		C
C10	VCC	-			ULC_SQ_VCCTX0	11		
A9	PT17A	0		T	ULC_SQ_HDOUTP0	11		T
A10	NC	-			ULC_SQ_VCCOB0	11		
B9	PT17B	0		C	ULC_SQ_HDOUTN0	11		C
C9	VCC	-			ULC_SQ_VCCTX1	11		
B8	PT18B	0		C	ULC_SQ_HDOUTN1	11		C
C8	NC	-			ULC_SQ_VCCOB1	11		
A8	PT18A	0		T	ULC_SQ_HDOUTP1	11		T
C12	VCC	-			ULC_SQ_VCCRX1	11		
B11	PT16B	0		C	ULC_SQ_HDINN1	11		C
C11	NC	-			ULC_SQ_VCCIB1	11		
A11	PT16A	0		T	ULC_SQ_HDINP1	11		T
B7	VCCAUX	-			ULC_SQ_VCCAUX33	11		
E7	PT15B	0		C	ULC_SQ_REFCLKN	11		C
D7	PT15A	0		T	ULC_SQ_REFCLKP	11		T
C7	VCC	-			ULC_SQ_VCCP	11		
A3	PT12A	0		T	ULC_SQ_HDINP2	11		T
C3	NC	-			ULC_SQ_VCCIB2	11		
B3	PT12B	0		C	ULC_SQ_HDINN2	11		C
C2	VCC	-			ULC_SQ_VCCRX2	11		
A6	PT14A	0		T	ULC_SQ_HDOUTP2	11		T
C6	NC	-			ULC_SQ_VCCOB2	11		
B6	PT14B	0		C	ULC_SQ_HDOUTN2	11		C
C5	VCC	-			ULC_SQ_VCCTX2	11		
B5	PT13B	0		C	ULC_SQ_HDOUTN3	11		C
A4	NC	-			ULC_SQ_VCCOB3	11		
A5	PT13A	0		T	ULC_SQ_HDOUTP3	11		T
C4	VCC	-			ULC_SQ_VCCTX3	11		
B2	PT11B	0		C	ULC_SQ_HDINN3	11		C
B1	NC	-			ULC_SQ_VCCIB3	11		
A2	PT11A	0		T	ULC_SQ_HDINP3	11		T
C1	VCC	-			ULC_SQ_VCCRX3	11		
L12	VCC	-			VCC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
D2	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
G6	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7	LDQ15	T
D1	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-		
G5	PL15A	7	LDQS15	T (LVDS)*
G4	PL15B	7	LDQ15	C (LVDS)*
K7	PL16A	7	LDQ15	T
K8	PL16B	7	LDQ15	C
E1	PL17A	7	LDQ15	T (LVDS)*
F2	PL17B	7	LDQ15	C (LVDS)*
F1	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-		
G3	PL18B	7	LDQ15	C
GNDIO	GNDIO7	-		
H5	PL25A	7	LDQ23	T (LVDS)*
H4	PL25B	7	LDQ23	C (LVDS)*
J5	PL26A	7	LDQ23	T
J4	PL26B	7	LDQ23	C
GNDIO	GNDIO7	-		
G2	PL28A	7	LDQ32	T (LVDS)*
G1	PL28B	7	LDQ32	C (LVDS)*
L9	PL29A	7	LDQ32	T
L7	PL29B	7	LDQ32	C
K6	PL30A	7	LDQ32	T (LVDS)*
K5	PL30B	7	LDQ32	C (LVDS)*
L8	PL31A	7	LDQ32	T
L6	PL31B	7	LDQ32	C
GNDIO	GNDIO7	-		
H3	PL32A	7	LDQS32	T (LVDS)*
H2	PL32B	7	LDQ32	C (LVDS)*
N8	PL33A	7	LDQ32	T
M9	PL33B	7	LDQ32	C
J3	PL34A	7	LDQ32	T (LVDS)*
-	-	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H33	PR14B	2	RDQ15	C	PR14B	2	RDQ15	C
GNDIO	GNDIO2	-			GNDIO2	-		
H34	PR14A	2	RDQ15	T	PR14A	2	RDQ15	T
J30	PR13B	2	RDQ15	C (LVDS)*	PR13B	2	RDQ15	C (LVDS)*
J29	PR13A	2	RDQ15	T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
J27	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
J28	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
H31	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
H32	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
H30	XRES	1			XRES	1		
B33	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
C33	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B34	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
C32	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
B32	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A33	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
C34	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
A32	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
B31	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
A31	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
D32	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A30	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
B30	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
C31	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
D31	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
C30	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
E29	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E30	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D30	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
D29	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
C29	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
D27	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
C28	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
B29	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A29	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
E28	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
A28	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
B28	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
A27	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
D26	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A26	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
B27	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
C27	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B26	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
C26	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
D28	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E5	ULC_SQ_REFCLKN	11		C	ULC_SQ_REFCLKN	11		C
D5	ULC_SQ_REFCLKP	11		T	ULC_SQ_REFCLKP	11		T
D6	ULC_SQ_VCCP	11			ULC_SQ_VCCP	11		
C5	ULC_SQ_HDINP2	11		T	ULC_SQ_HDINP2	11		T
D4	ULC_SQ_VCCIB2	11			ULC_SQ_VCCIB2	11		
C4	ULC_SQ_HDINN2	11		C	ULC_SQ_HDINN2	11		C
B5	ULC_SQ_VCCRX2	11			ULC_SQ_VCCRX2	11		
A5	ULC_SQ_HDOUTP2	11		T	ULC_SQ_HDOUTP2	11		T
D3	ULC_SQ_VCCOB2	11			ULC_SQ_VCCOB2	11		
A4	ULC_SQ_HDOUTN2	11		C	ULC_SQ_HDOUTN2	11		C
B4	ULC_SQ_VCCTX2	11			ULC_SQ_VCCTX2	11		
A3	ULC_SQ_HDOUTN3	11		C	ULC_SQ_HDOUTN3	11		C
C1	ULC_SQ_VCCOB3	11			ULC_SQ_VCCOB3	11		
A2	ULC_SQ_HDOUTP3	11		T	ULC_SQ_HDOUTP3	11		T
B3	ULC_SQ_VCCTX3	11			ULC_SQ_VCCTX3	11		
C3	ULC_SQ_HDINN3	11		C	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11			ULC_SQ_VCCIB3	11		
C2	ULC_SQ_HDINP3	11		T	ULC_SQ_HDINP3	11		T
B2	ULC_SQ_VCCRX3	11			ULC_SQ_VCCRX3	11		
AA13	VCC	-			VCC	-		
AA14	VCC	-			VCC	-		
AA15	VCC	-			VCC	-		
AA16	VCC	-			VCC	-		
AA17	VCC	-			VCC	-		
AA18	VCC	-			VCC	-		
AA19	VCC	-			VCC	-		
AA20	VCC	-			VCC	-		
AA21	VCC	-			VCC	-		
AA22	VCC	-			VCC	-		
AB14	VCC	-			VCC	-		
AB15	VCC	-			VCC	-		
AB20	VCC	-			VCC	-		
AB21	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N15	VCC	-			VCC	-		
N20	VCC	-			VCC	-		
N21	VCC	-			VCC	-		
P13	VCC	-			VCC	-		
P14	VCC	-			VCC	-		
P15	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
P17	VCC	-			VCC	-		
P18	VCC	-			VCC	-		
P19	VCC	-			VCC	-		
P20	VCC	-			VCC	-		
P21	VCC	-			VCC	-		
P22	VCC	-			VCC	-		
R13	VCC	-			VCC	-		
R14	VCC	-			VCC	-		

Date	Version	Section	Change Summary
June 2013 (cont.)	04.0 (cont.)	DC and Switching Characteristics	sysCLOCK SPLL Timing table – Corrected signal names for t_{RST} parameter.
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added t_{SUMCDI} and t_{HMCDI} parameters.
September 2013	04.1	Architecture	Updated Selectable Master Clock (CCLK) Frequencies during Configuration table.
		DC and Switching Characteristics	Added information on f_{MAXSPI} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.